

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Yutaka TAKAGI et al.	Art Unit: 3652
Application No.: 10/809,679	
Filing or 371(c) Date: March 26, 2004	Examiner: G. Lupino
Title: HANDLING DEVICE FOR ELECTRONIC CHIP COMPONENTS AND HANDLING METHOD FOR ELECTRONIC CHIP COMPONENTS	

**INFORMATION DISCLOSURE STATEMENT COVER LETTER**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

In accordance with 37 CFR § 1.56, Applicant submits references, including references cited in any included Official Communication issued in a corresponding non-U.S. application, with the attached Form PTO/SB/08a.

Where available, Applicant has provided:

- 1) English language equivalents of the foreign language references cited in the included Official Communication or Applicant's Specification and has not provided the foreign language references;
- 2) English language abstracts of the provided foreign language references obtained from a corresponding foreign Patent Office; and
- 3) English machine translations of the provided Japanese references that were prepared by the Intellectual Property Digital Library of the Japanese Patent Office.

The statement is not a representation that all of the information cited is necessarily effective as prior art against the application.

Respectfully submitted,

Dated: November 15, 2007

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